

PCN# 20221201000.1A Qualification of ASEN as Additional Assembly Site for Select Package Devices Change Notification / Sample Request

Date: December 09, 2022 To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

Revision A is to announce the <u>addition</u> of a new device that was not included on the original PCN notification.

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (<u>PCN ww admin team@list.ti.com</u>). For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

PCN Team SC Business Services

20221201000.1A Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TPS3422EGDRYR	null
TPS3895ADRYT	null
SN74LVC1G126DRYR	null
TPS3898ADRYR	null
TPS3898ADRYT	null
TPS622314DRYR	null
TPS622314DRYT	null
TPS62237DRYR	null
SN74LVC1G07DRYR	null
SN74LVC1G3157DRYR	null
TPS3421EGDRYT	null
TPS3898PDRYR	null
TPS3422EGDRYT	null
TPS62237DRYT	null
SN74LVC1G125DRYR	null
SN74LVC1G14DRYR	null
TPS3895ADRYR	null

Technical details of this Product Change follow on the next page(s).

PCN Number:			20	20221201000.1A					PCN Date:	Dece 2022	mber09,		
Title	Title: Qualification of ASEN as Additional Assembly Site for Select Package Devices												
Cust	Customer Contact: PCN Manager Dept: Quality Services												
Proposed 1 st Ship Date		te:	e: Mar 02, 2023			Sample requests accepted until:			Jan 09, 2023*				
*Sample requests received after "Jan 09, 2023" will not be supported.													
Change Type:													
		sembly Site			Design				Wafer Bu				
Assembly Process				Data Sheet				Wafer Bu	•				
Assembly Materials				Part number change Test Site			hange		Wafer Bu	•	ess		
Mechanical Specifica						Site Process		Wafer Fab Site					
Packing/Shipping/La		Labe	anny	_ L		Test	PIUCESS			Wafer Fa			
	PCN Details												
Desc	crinti	on of Chang	e '				F CI	Detai	15				
Revision A is to announce the addition of new devices that was not included on the original PCN notification. The new devices are highlighted and bolded in the device list below. The expected first shipment date for the new devices will be 90 days from this notice (Mar 09, 2023) for the newly added devices only. The proposed 1 st ship date of Mar 02, 2023 still applies for the original set of devices.Texas Instruments Incorporated is announcing the qualification of ASEN as Additional Assembly Site for select devices listed in the "Product Affected" Section. Current assembly sites and Material differences are as follows.Assembly SiteAssembly Site OriginAssembly Country CodeAssembly Site City													
	UTAC	;	NS	NSE			THA			Bangkok			
	ASEN		AS	N				CHN			Suzhou		
Material Differences:UTACASENMold CompoundCZ01381801512111													
Reas	son fo	or Change:											
Cont	inuity	of supply.											
Anti	cipate	ed impact o	n Fo	orm, Fit	t, F	un	ction	, Quality	or Relia	bilit	y (positive	/ negat	ive):
None	9												
Imp	act o	n Environm	enta	l Ratin	ngs	:							
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.													
RoHS			REACH				Green Status		IEC 62474				
	a ino C	Change		🛛 No Change			🛛 No Change		🛛 No Change				
Changes to product identification resulting from this PCN:													
		ly Site		I	-			<u></u>	(00)	1			
	AC				Assembly Site Origin (22L)			ASO: NSE					
AS	ASEN			A	Assembly Site Origin (22L)			ASO: ASN					

Sample product shipping label (not actual product label)						
INSTRUMENTS MADE IN: Malaysia 2DC:G4 2G:(1P) SN74LS07NSR (Q) 2000 (D) 0336 (31T) LOT: 3959047MLA (4W) TKY (1T) 7523483S12OPT: ITEM: IEBL:39 CPT: COPT: ITEM: LBL: 5A (L)T0:1750(1P) SN74LS07NSR (Q) 2000 (D) 0336 (31T) LOT: 3959047MLA (4W) TKY (1T) 7523483S12 (P) (2D) CS0: SHE (21L) CC0:USA (23L) AC0: MYS						
Product Affected:						
74LVC1G3157DRYRG4	TPS3421ECDRYR	TPS3896ADRYT	TPS62237DRYR			
<mark>SN74LVC1G07DRYR</mark>	TPS3421ECDRYT	TPS3896PDRYR	TPS62237DRYT			
SN74LVC1G07DRYRG4	TPS3421EGDRYR	TPS3896PDRYT	TPS62730DRYR			
SN74LVC1G125DRYR	TPS3421EGDRYT	TPS3898ADRYR	TPS62730DRYT			
SN74LVC1G125DRYR SN74LVC1G126DRYR	TPS3421EGDRYT TPS3422EGDRYR	TPS3898ADRYR TPS3898ADRYT	TPS62730DRYTTPS62732DRYR			
SN74LVC1G126DRYR	TPS3422EGDRYR	TPS3898ADRYT	TPS62732DRYR			
<mark>SN74LVC1G126DRYR</mark> SN74LVC1G14DRYR	TPS3422EGDRYR TPS3422EGDRYT	TPS3898ADRYT TPS3898PDRYR	TPS62732DRYR TPS62732DRYT			
SN74LVC1G126DRYR SN74LVC1G14DRYR SN74LVC1G175DRYR	TPS3422EGDRYR TPS3422EGDRYT TPS3895ADRYR	TPS3898ADRYT TPS3898PDRYR TPS3898PDRYT	TPS62732DRYR TPS62732DRYT TPS62733DRYR			
SN74LVC1G126DRYR SN74LVC1G14DRYR SN74LVC1G175DRYR SN74LVC1G3157DRYR	TPS3422EGDRYR TPS3422EGDRYT TPS3895ADRYR TPS3895ADRYT	TPS3898ADRYT TPS3898PDRYR TPS3898PDRYT TPS622311DRYR	TPS62732DRYR TPS62732DRYT TPS62733DRYR			

Qualification Report

Approved Date 21-Nov-2022

Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TCA6507RUER	
PC	Preconditioning	Level 1 - 260C	3/693/0	
TC	Temperature Cycle, -55C/125C	700 Cycles	3/231/0	
SAM	Post Temperature Cycle SAM	Devices	3/15/0	
UHAST	Unbiased HAST, 130C	96 Hours	3/231/0	
SAM	Post Unbiased HAST SAM	Devices	3/15/0	
BHAST	Biased HAST, 130C	96 Hours	3/231/0	
SAM	Post Biased HAST SAM	Devices	3/15/0	
SD	Solderability, Pb	155C Dry Bake Preconditioning	3/66/0	
SD	Solderability, Pb-Free	155C Dry Bake Preconditioning	3/66/0	
BBS	Ball Bond Shear	Ball Bonds	3/228/0	
WBP	Wire Bond Pull	Wires	3/228/0	
PD	Physical Dimensions	(per package draw ing requirements)	3/60/0	
MQ	Manufacturability (Assembly)	(per mfg. site requirements)	3/PASS	
DSS	Die Shear Strength	Die	3/30/0	
CHAR	Electrical Characterization	Devices	1/30/0	
MSL	Moisture Sensitivity Level	Level 1 - 260C	3/36/0	
YLD	FTY and Bin Summary	Lots	3/PASS	

Qual Device TCA6507RUER is qualified at MSL1-260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent Temperature Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free (SMT) and Green

Qualification Report

Approved Date 02-Dec-2022

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: SN74LVC1G07DRYR	
PC	Preconditioning	Level 1 - 260C	3/693/0	
TC	Temperature Cycle, -55C/125C	700 Cycles	3/231/0	
SAM	Post Temperature Cycle SAM	Devices	3/15/0	
UHAST	Unbiased HAST, 130C	96 Hours	3/231/0	
SAM	Post Unbiased HAST SAM	Devices	3/15/0	
BHAST	Biased HAST, 130C	96 Hours	3/231/0	
SAM	Post Biased HAST SAM	Devices	3/15/0	
SD	Solderability, Pb-Free	155C Dry Bake Preconditioning	3/66/0	
BBS	Ball Bond Shear	Ball Bonds	3/228/0	
WBP	Wire Bond Pull	Wires	3/228/0	
PD	Physical Dimensions	(per package draw ing requirements)	3/60/0	
MQ	Manufacturability (Assembly)	(per mfg. site requirements)	3/PASS	
DSS	Die Shear Strength	Die	3/30/0	
CHAR	Electrical Characterization	Devices	1/30/0	
MSL	Moisture Sensitivity Level	Level 1 - 260C	3/36/0	
YLD	FTY and Bin Summary	Lots	3/PASS	

Qual Device SN74LVC1G07DRYR is qualified at MSL1-260C

Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

The following are equivalent Temperature Cycle options per JESD47: -55C/125C/700 Cycles and - 65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/ Green/Pb-free Status: Qualified Pb-Free (SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN ww admin team@list.ti.com

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